

# STGW30NC60WD

## 30 A, 600 V ultra fast IGBT

## Features

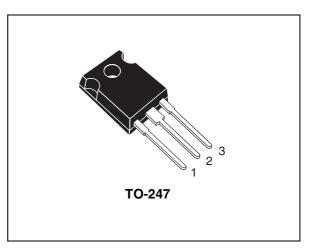
- High frequency operation
- Lower C<sub>RES</sub> / C<sub>IES</sub> ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode

## **Applications**

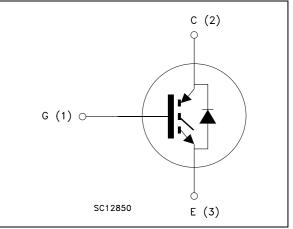
- High frequency motor controls, inverters, UPS
- HF, SMPS and PFC in both hard switch and resonant topologies

## Description

This IGBT utilizes the advanced Power MESH<sup>™</sup> process resulting in an excellent trade-off between switching performance and low on-state behavior.



### Figure 1. Internal schematic diagram



#### Table 1. Device summary

Order code	Marking	Package	Packaging
STGW30NC60WD	STGW30NC60WD GW30NC60WD		Tube

# Contents

1	Electrical ratings
2	Electrical characteristics
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# 1 Electrical ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GE</sub> = 0)	600	V
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at 25 °C	60	А
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at 100 °C	30	А
I <sub>CP</sub> <sup>(2)</sup>	Collector current (pulsed)	150	А
I <sub>CL</sub> <sup>(3)</sup>	Turn-off latching current	150	А
V <sub>GE</sub>	Gate-emitter voltage	± 20	V
١ <sub>F</sub>	Diode RMS forward current at $T_C = 25 \ ^{\circ}C$	30	Α
I <sub>FSM</sub>	Surge not repetitive forward current t <sub>p</sub> = 10 ms sinusoidal	120	А
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \ ^{\circ}C$	200	W
T <sub>stg</sub>	Storage temperature	– 55 to 150	°C
Тj	Operating junction temperature	- 55 10 150	C

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Pulse width limited by max junction temperature
- 3.  $V_{CLAMP} = 80\%$  ( $V_{CES}$ ),  $V_{GE} = 15$  V,  $R_G = 10 \ \Omega$ ,  $T_J = 150 \ ^{\circ}C$

#### Table 3.Thermal resistance

Symbol	Parameter	Value	Unit
Bu	Thermal resistance junction-case IGBT max.	0.63	°C/W
R <sub>thj-case</sub>	Thermal resistance junction-case diode max.	1.5	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max.	50	°C/W



# 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage (V <sub>GE</sub> = 0)	I <sub>C</sub> = 1 mA	600			v
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 20 A $V_{GE}$ = 15V, I <sub>C</sub> = 20 A,T <sub>C</sub> = 125 °C		2.1 1.8	2.5	V V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250 \mu A$	3.75		5.75	V
I <sub>CES</sub>	Collector cut-off current (V <sub>GE</sub> = 0)	V <sub>CE</sub> = 600 V V <sub>CE</sub> = 600 V, T <sub>C</sub> = 125 °C			250 1	μA mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ±20 V			± 100	nA
9 <sub>fs</sub>	Forward transconductance	$V_{CE} = 15 V_{,} I_{C} = 20 A$		15		S

### Table 4. Static electrical characteristics

### Table 5. Dynamic electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0		2080 175 52		pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	V <sub>CE</sub> = 390 V, I <sub>C</sub> = 20 A, V <sub>GE</sub> = 15 V, <i>(see Figure 18)</i>		102 17.5 47	140	nC nC nC



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ <i>(see Figure 17)</i>		29.5 12 1640		ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega \text{ V}_{GE} = 15 \text{ V},$ $T_{C} = 125 \text{ °C} \text{ (see Figure 17)}$		29 13.5 1600		ns ns A/µs
t <sub>r</sub> (V <sub>off</sub> ) t <sub>d</sub> ( <sub>off</sub> ) t <sub>f</sub>	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 20 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V}$ <i>(see Figure 17)</i>		19.5 118 27		ns ns ns
$t_r(V_{off})$ $t_d(_{off})$ $t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}, I_C = 20 \text{ A},$ $R_{GE} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_C = 125 \text{ °C}$ <i>(see Figure 17)</i>		46 151 38		ns ns ns

 Table 6.
 Switching on/off (inductive load)

 Table 7.
 Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}, I_C = 20 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ <i>(see Figure 19)</i>		305 181 486		μJ μJ μJ
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}, I_C = 20 \text{ A}$ $R_G = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_C = 125^{\circ}\text{C}$ (see Figure 19)		455 355 810		μJ μJ

 Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 19*. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C). Eon include diode recovery energy.



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>F</sub>	Forward on-voltage	I <sub>F</sub> = 20 A I <sub>F</sub> = 20 A, T <sub>C</sub> = 125 °C		2.6 1.6		V V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 50 \text{ V},$ di/dt = 100 A/µs (see Figure 20)		40 50 2.5		ns nC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>rrm</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 50 \text{ V},$ $T_C = 125 \text{ °C}, \text{ di/dt} = 100$ $A/\mu s$ <i>(see Figure 20)</i>		80 180 4.5		ns nC A

 Table 8.
 Collector-emitter diode



## 2.1 Electrical characteristics (curves)

### Figure 2. Output characteristics

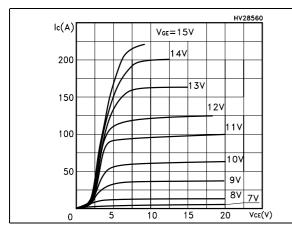


Figure 4. Transconductance

Vce=15V

T」=−50℃

150℃

10

15

g fs(S)

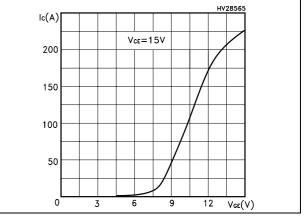
18

15

12

9

3



**Transfer characteristics** 

Figure 3.

Figure 5. Collector-emitter on voltage vs temperature

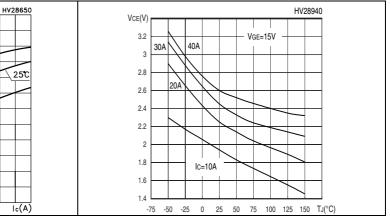
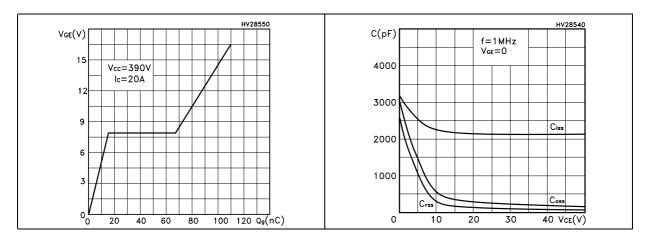


Figure 6. Gate charge vs gate-source voltage Figure 7. Capacitance variations



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HV28950

TJ=150°C

# Figure 8. Normalized gate threshold voltage vs temperature

# Figure 9. Collector-emitter on voltage vs collector current

TJ=25°C

5 10 15 20 25 30 35 40 45 50 55 60 lc(A)

VCE(sat)

(V)

3.2

3 2.8

2.6 2.4 2.2

2 1.8

1.6 1.4

1.2 1 0.8

0

TJ=-50°C

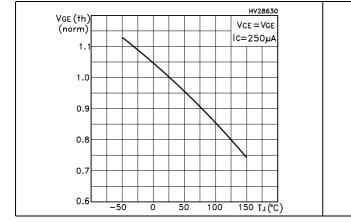
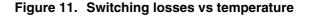


Figure 10. Normalized breakdown voltage vs temperature



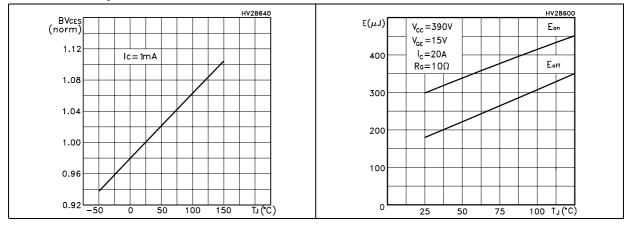
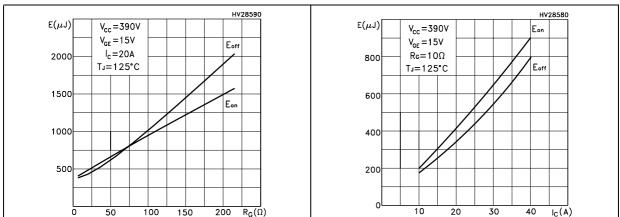


Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current



### Figure 14. Thermal impedance

Figure 15. Turn-off SOA

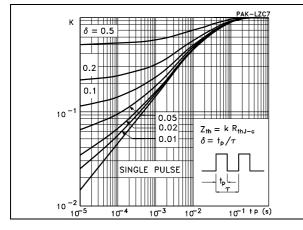
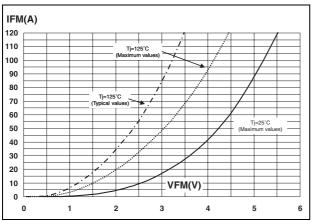
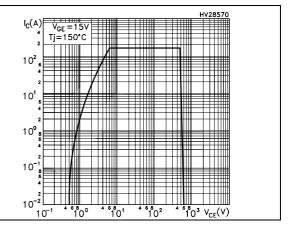


Figure 16. Emitter-collector diode characteristics





## 3 Test circuit

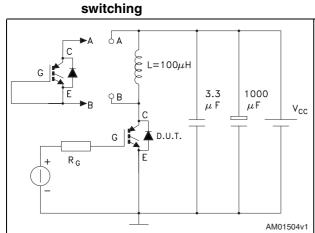
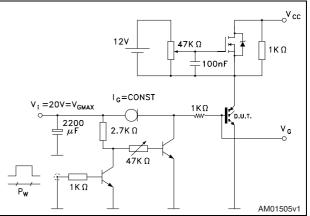


Figure 17. Test circuit for inductive load



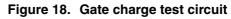
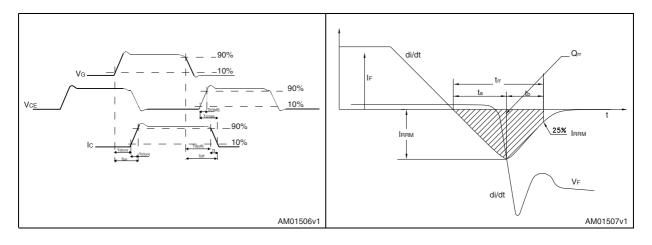


Figure 19. Switching waveform





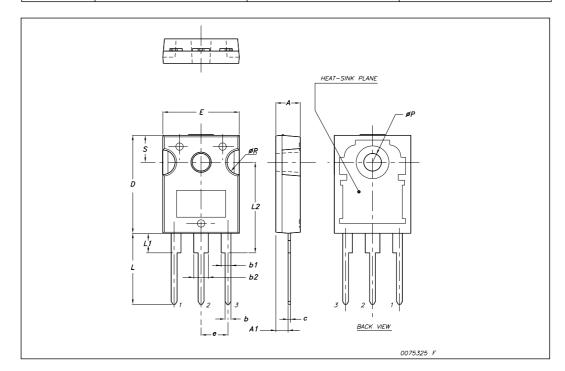


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: *www.st.com* 



	TO-247 Mechanical data		
Dim.		mm.	1
	Min.	Тур	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
с	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øP	3.55		3.65
øR	4.50		5.50
S		5.50	





# 5 Revision history

### Table 9.Document revision history

Date	Revision	Changes
21-Nov-2005	1	Initial release.
29-Nov-2005	2	Modified <i>Figure 5</i> and <i>Figure 6</i>
06-Mar-2006	3	New template
12-Jul-2007	4	Corrected Figure 11, Figure 12, Figure 13
11-Nov-2008	5	Figure 16 has been updated.



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